### **Data Sheet**



# HSMQ-C1xx and HSMR-C1xx High-Performance Chip LED



# **Description**

These Broadcom<sup>®</sup> small chip-type LEDs use high-efficient and high-brightness InGaN material to deliver competitively priced high-performance blue and green. These 520-nm green and 470-nm blue are unique hues that provide color differentiation to a product.

These chipLEDs come in either top-emitting packages (HSMx-C130, C150, C170, C177, C190, C191, C197), in side-emitting packages (HSMx-C110, C120) or in a reverse-mount package (HSMx-C265). The side-emitting package is especially suitable for LCD backlighting application. The top-emitting packages, with their wide viewing angle, are suitable for direct backlighting application or being used with light pipes.

To facilitate pick-and-place operation, these chipLEDs are shipped in tape and reel with 4000 units per reel for HSMx-C120, C130, C170, C177, C190, C191, and C197 packages, and 3000 units per reel for HSMx-C110, C150, and C265 packages. All packages are compatible with IR soldering and binned by both color and intensity.

#### **Features**

- High brightness
- Small size
- Industrial standard footprint
- Diffused optics
- Top-emitting or right-angle emitting
- Compatible with IR soldering
- Compatible for use with light piping
- Available in 8-mm tape on 7-in. diameter reels
- Reel sealed in zip-locked moisture barrier bags

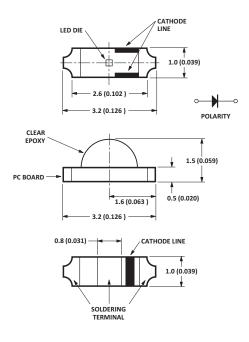
# **Applications**

- LCD backlighting
- Push button backlighting
- Front panel indicator
- Symbol indicator
- Microdisplays
- Small message panel signage

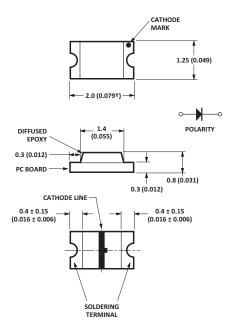
**CAUTION!** HSMQ-Cxxx and HSMR-Cxxx LEDs are Class 1A ESD sensitive per JESD22-A114C.01. Observe appropriate precautions during handling and processing. Refer to Broadcom Application Note AN-1142 for additional details.

# **Package Dimensions**

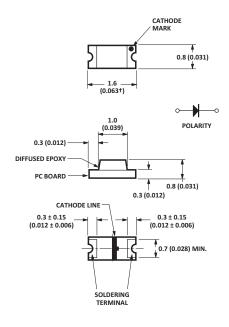
# HSMx-C110



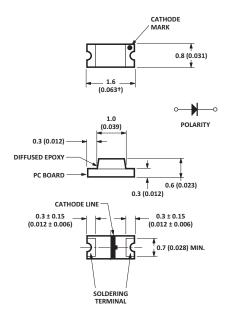
#### HSMx-C170



# HSMx-C190



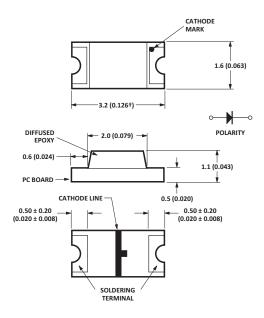
# HSMx-C191



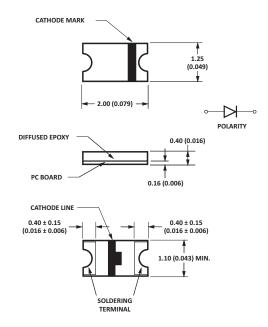
#### NOTE:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.1 mm (± 0.004 in.) unless otherwise noted.

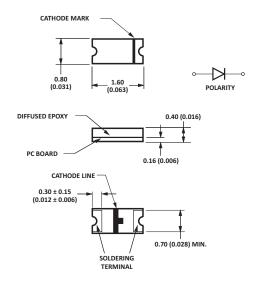
# HSMx-C150



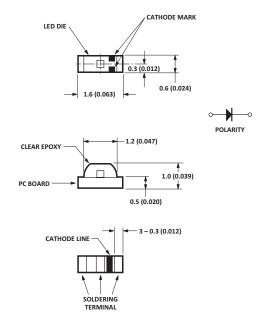
# HSMx-C177



# HSMx-C197



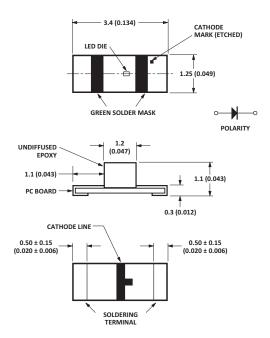
# HSMx-C120



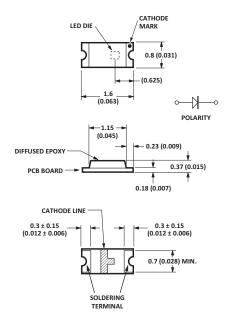
#### NOTE:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.1 mm (± 0.004 in.) unless otherwise noted.

# HSMx-C265



# HSMx-C130



#### NOTE:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.1 mm (± 0.004 in.) unless otherwise noted.

# **Device Selection Guide**

Package Dimension (mm) <sup>a</sup> , <sup>b</sup>	InGaN Green	InGaN Blue	Package Description
3.2 (L) × 1.5 (W) × 1.0 (H)	HSMQ-C110	HSMR-C110	Untinted, Non-diffused
1.6 (L) × 1.0 (W) × 0.6 (H)	HSMQ-C120	HSMR-C120	Untinted, Non-diffused
1.6 (L) × 0.8 (W) × 0.37 (H)	_	HSMR-C130	Untinted, Diffused
3.2 (L) × 1.6 (W) × 1.1 (H)	HSMQ-C150	HSMR-C150	Untinted, Diffused
2.0 (L) × 1.25 (W) × 0.8 (H)	HSMQ-C170	HSMR-C170	Untinted, Diffused
2.0 (L) × 1.25 (W) × 0.4 (H)	HSMQ-C177	HSMR-C177	Untinted, Diffused
1.6 (L) × 0.8 (W) × 0.8 (H)	HSMQ-C190	HSMR-C190	Untinted, Diffused
1.6 (L) × 0.8 (W) × 0.6 (H)	HSMQ-C191	HSMR-C191	Untinted, Diffused
1.6 (L) × 0.8 (W) × 0.4 (H)	HSMQ-C197	HSMR-C197	Untinted, Diffused
3.4 (L) × 1.25 (W) × 1.1(H)	HSMQ-C265	HSMR-C265	Untinted, Non-diffused

- a. Dimensions are in mm.
- b. Tolerance is  $\pm 0.1$  mm unless otherwise noted.

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# Absolute Maximum Ratings at $T_A = 25$ °C

Parameter	HSMQ-Cxxx, HSMR-Cxxx	Units
DC Forward Current <sup>a</sup>	20	mA
Power Dissipation	78	mW
Reverse Voltage (IR = 100 μA)	5	V
LED Junction Temperature	95	°C
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range	-40 to +85	°C
Soldering Temperature	See reflow soldering profile (Figure 11 and Figure 12)	

a. Derate linearly as shown in Figure 4.

# Electrical Characteristics at $T_A = 25$ °C

	Forward Voltage $V_F$ (V) at $I_F$ = 20 mA at $I_R$ = 100 $\mu$ A		Reverse Breakdown V <sub>R</sub> (V), f = 1 MHz	Capacitance C (pF), $V_F = 0$ , $R\theta_{J-PIN}$ (°C/W)	Thermal Resistance
Part Number	Тур.	Max.	Min.	Тур.	Тур.
HSMQ-C110/C150	3.4	3.9	5	140	450
HSMR-C110/C150	3.4	3.9	5	140	450
HSMQ-C120	3.4	3.9	5	100	450
HSMR-C120/C130	3.4	3.9	5	100	450
HSMQ-C170/C190/C191	3.4	3.9	5	110	300
HSMR-C170/C190/C191	3.4	3.9	5	110	300
HSMQ-C177/C197	3.4	3.9	5	110	350
HSMR-C177/C197	3.4	3.9	5	110	350
HSMQ-C265	3.4	3.9	5	65	300
HSMR-C265	3.4	3.9	5	65	300

 $V_F$  tolerance:  $\pm$  0.1V.

# Optical Characteristics at $T_A = 25$ °C

		Luminous Inte	• •	Color Peak Wavelength, λ <sub>PEAK</sub> (nm)	Viewing Dominant Wavelength, $\lambda_D^{\ b}$ (nm)	Luminous Angle, 2θ <sub>½</sub> , Degrees <sup>c</sup>	Efficacy, η <sub>V</sub> , (lm/w)
Part Number	Color	Min.	Тур.	Тур.	Тур.	Тур.	Тур.
HSMQ-C110	Green	45	150	520	527	130	500
HSMQ-C120	Green	45	145	520	527	155	500
HSMQ-C150/170/190/191	Green	45	145	520	527	140	500
HSMQ-C177/197	Green	45	145	520	527	130	500
HSMQ-C265	Green	45	140	520	527	150	500
HSMR-C110	Blue	18	60	469	473	130	88
HSMR-C120	Blue	18	55	469	473	155	88
HSMR-C130	Blue	18	55	469	473	145	88
HSMR-C150/170/190/191	Blue	18	55	469	473	140	88
HSMR-C177/197	Blue	18	55	469	473	130	88
HSMR-C265	Blue	18	45	469	473	150	88

a. The luminous intensity, I<sub>V</sub>, is measured at the peak of the spatial radiation pattern which may not be aligned with the mechanical axis of the lamp package.

# Color Bin Limits<sup>1</sup>

# Blue Color Bins<sup>1</sup>

Tolerance: ± 1 nm.

	Dom. Wavelength (nm)		
Bin ID	Min.	Max.	
Α	460.0	465.0	
В	465.0	470.0	
С	470.0	475.0	
D	475.0	480.0	

# InGaN Green Color Bins<sup>1</sup>

Tolerance: ± 1 nm.

	Dominant Wavelength (nm)		
Bin ID	Min.	Max.	
Α	515.0	520.0	
В	520.0	525.0	
С	525.0	530.0	
D	530.0	535.0	

b. The dominant wavelength,  $\lambda d$ , is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.

c.  $\theta_{\frac{1}{2}}$  is the off-axis angle where the luminous intensity is  $\frac{1}{2}$  the peak intensity.

<sup>1.</sup> Bin categories are established for classification of products. Products may not be available in all categories. Contact your Broadcom representative for information on currently available bins.

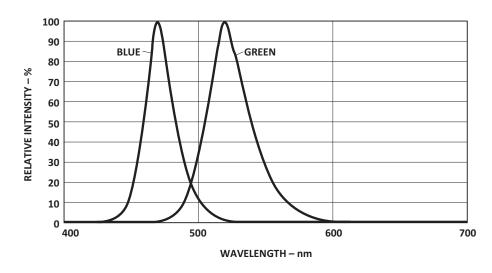
# Light Intensity (Iv) Bin Limits<sup>2</sup>, <sup>3</sup>

	Intensity (mcd)		
Bin ID	Min.	Max.	
Α	0.11	0.18	
В	0.18	0.29	
С	0.29	0.45	
D	0.45	0.72	
Е	0.72	1.10	
F	1.10	1.80	
G	1.80	2.80	
Н	2.80	4.50	
J	4.50	7.20	
K	7.20	11.20	
L	11.20	18.00	
M	18.00	28.50	

	Intensity (mcd)		
Bin ID	Min.	Max.	
N	28.50	45.00	
Р	45.00	71.50	
Q	71.50	112.50	
R	112.50	180.00	
S	180.00	285.00	
Т	285.00	450.00	
U	450.00	715.00	
V	715.00	1125.00	
W	1125.00	1800.00	
X	1800.00	2850.00	
Υ	2850.00	4500.00	

Tolerance: ±15%

Figure 1: Relative Intensity vs. Wavelength



<sup>2.</sup> Bin categories are established for classification of products. Products may not be available in all categories. Contact your Broadcom representative for information on currently available bins.

<sup>3.</sup> The lv binning specification setup is for lowest allowable lv binning only. There are no upper lv bin limits.

Figure 2: Forward Current vs. Forward Voltage

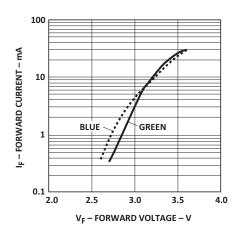


Figure 3: Luminous Intensity vs. Forward Current

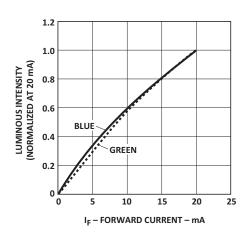


Figure 4: Maximum Forward Current vs. Ambient Temperature

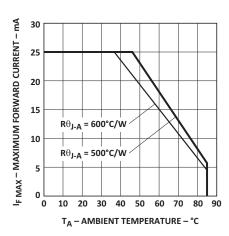


Figure 5: Relative Intensity vs. Angle for HSMx-C110

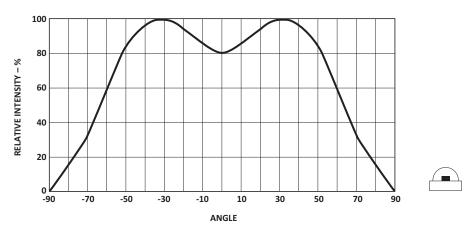


Figure 6: Relative Intensity vs. Angle for HSMx-C110

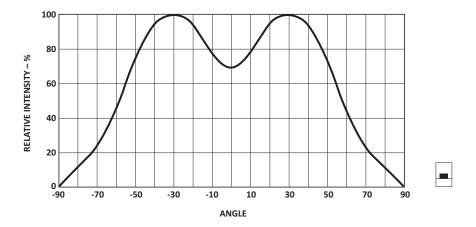


Figure 7: Relative Intensity vs. Angle for HSMx-C120

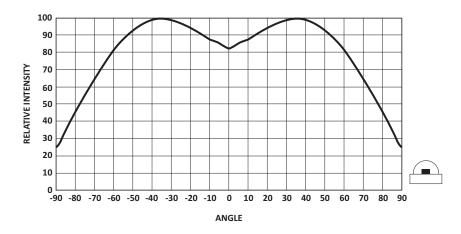


Figure 8: Relative Intensity vs. Angle for HSMx-C120

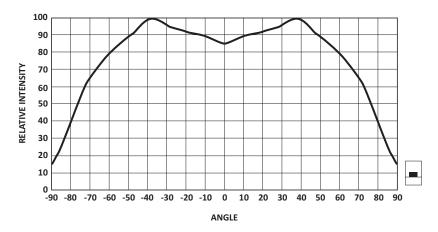
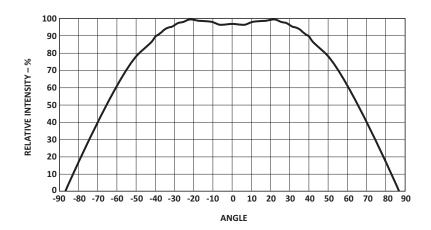


Figure 9: Relative Intensity vs. Angle for HSMx-C177 and C197



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Figure 10: Relative Intensity vs. Angle for HSMx-C130

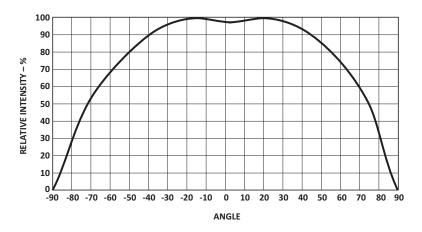


Figure 11: Relative Intensity vs. Angle for HSMx-C170, C190, C191, and C150

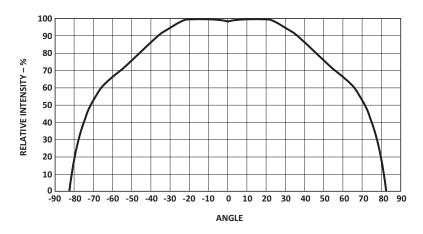


Figure 12: Relative Intensity vs. Angle for HSMx-C265

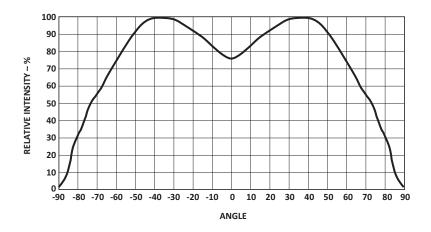


Figure 13: Recommended Reflow Soldering Profile

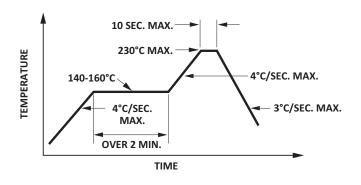


Figure 14: Recommended Pb-free Reflow Soldering Profile

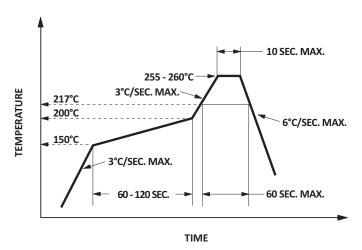


Figure 15: Recommended Soldering Pattern for HSMx-C110

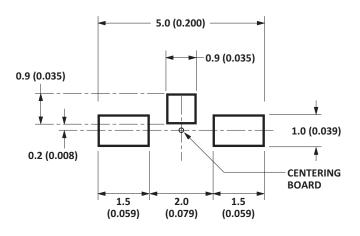


Figure 16: Recommended Soldering Pattern for HSMx-C170/

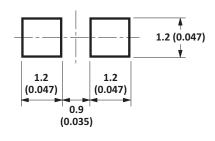


Figure 17: Recommended Soldering Pattern for HSMx-C130/ 190/191/197

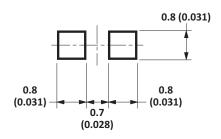


Figure 18: Recommended Soldering Pattern for HSMx-C150

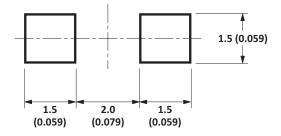


Figure 19: Recommended Soldering Pattern for HSMx-C120

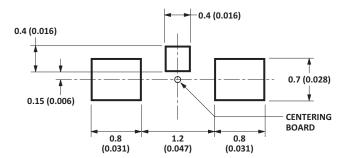


Figure 20: Recommended Soldering Pattern for HSMx-C265

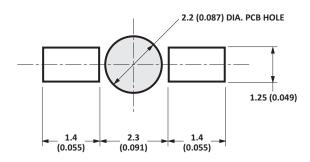


Figure 21: Reeling Orientation

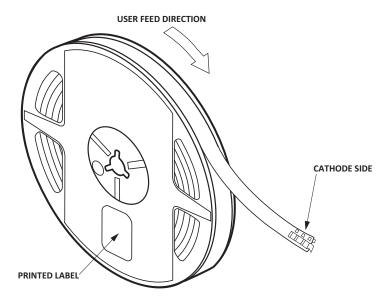


Figure 22: Reel Dimensions

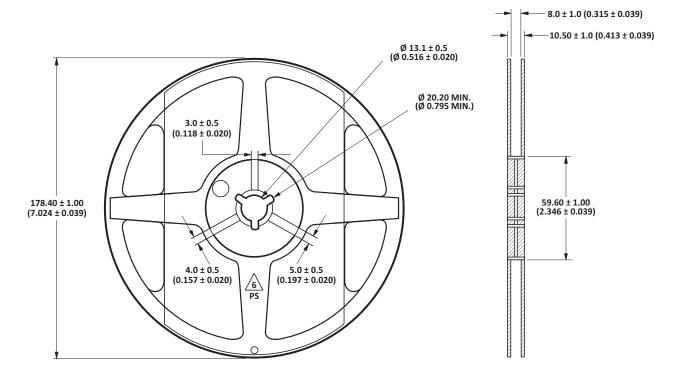


Figure 23: Tape Dimensions

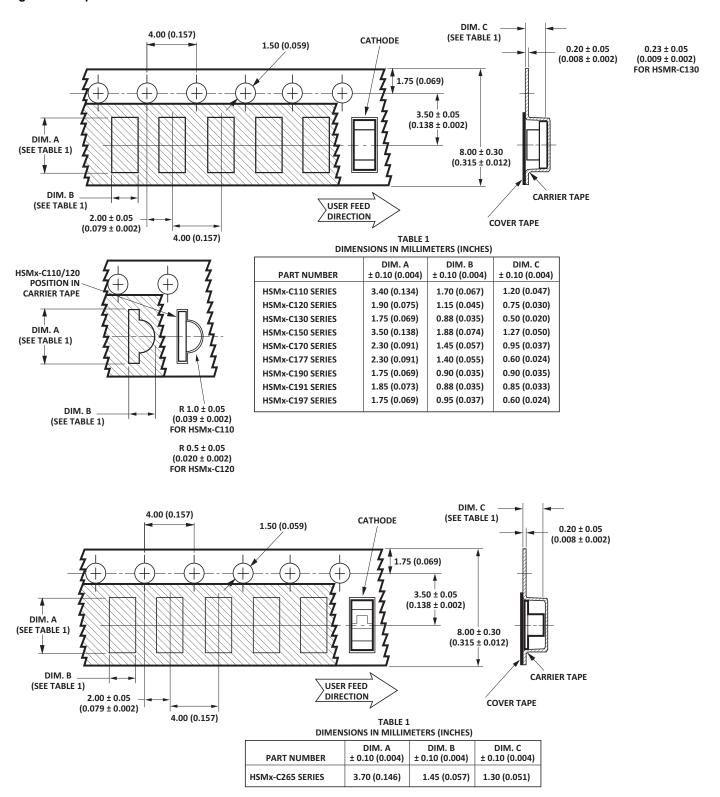
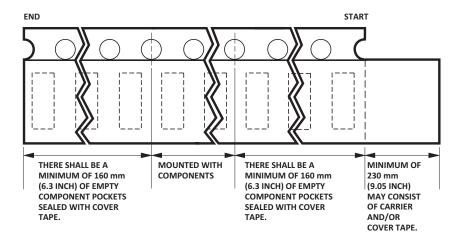


Figure 24: Tape Leader and Trailer Dimensions



#### NOTE:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.1 mm (± 0.004 in.) unless otherwise specified.

# **Convective IR Reflow Soldering**

For more information on IR reflow soldering, refer to Application Note 1060, *Surface Mounting SMT LED Indicator Components*.

# **Storage Condition**

5°C to 30°C @ 60% RH maximum.

Baking is required under the following conditions:

- The humidity indicator card is >10% when read at 23°C ± 5°C.
- 2. The device is exposed to factory conditions <30°C/60% RH for more than 672 hours.

Baking recommended conditions: 60°C ± 5°C for 20 hours.

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